

DATA SHEET

AWB7132: 2.30 to 2.40 GHz Small-Cell Power Amplifier Module

Applications

- LTE, WCDMA and HSDPA air interfaces
- Picocell, femtocell, home nodes
- Customer premises equipment
- · Data cards and terminals

Features

- InGaP HBTtechnology
- -47 dBc ACPR @ ±10 MHz, +24.5 dBm
- 29 dB gain
- High efficiency
- Low transistor junction temperature
- ullet Matched for a 50 Ω system
- Low profile miniature surface-mount package; RoHS compliant
- · Multi-carrier capability
- Surface-mount (14-pin, $7 \times 7 \times 1.3$ mm) package (MSL rating TBD, 260 °C per JEDEC J-STD-020)



Skyworks GreenTM products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green*TM, document number SQ04-0074.



Description

The AWB7132 is a highly linear, fully matched, power amplifier module designed for picocell, femtocell, and customer premises equipment (CPE) applications. Its high-power efficiency and low adjacent channel power levels meet the extremely demanding needs of small-cell infrastructure architectures.

Designed for LTE, WCDMA, HSDPA air interfaces operating in the 2.30 GHz to 2.40 GHz band, the AWB7132 delivers up to +24.5 dBm of LTE (E-TM1.1) power with an ACPR of -47 dBc. The device operates from a convenient +4.2 V supply and provides 28 dB of gain. The device is manufactured using an advanced InGaP HBT MMIC technology offering state-of-the-art reliability, temperature stability, and ruggedness. The self-contained 7 mm x 7 mm x 1.3 mm surface-mount package incorporates RF matching networks optimized for output power, efficiency, and linearity in a 50 Ω system.

A block diagram of the AWB7132 is shown in Figure 1. The device package and pinout are shown in Figure 2. Signal pin assignments and functional pin descriptions are described in Table 1.

DATA SHEET • AWB7132: 2.30 TO 2.40 GHz SMALL-CELL POWER AMPLIFIER MODULE

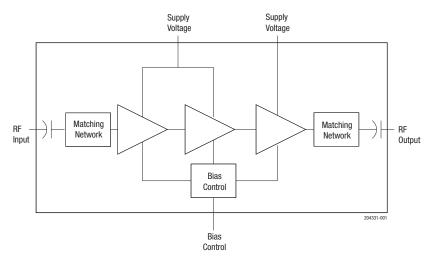


Figure 1. AWB7132 Block Diagram

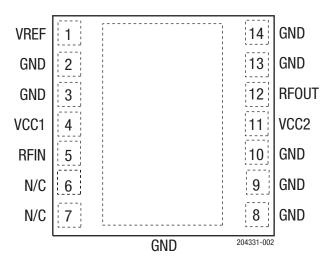


Figure 2. AWB7132 Pinout (Top View)

Table 1. AWB7124 Signal Pin Descriptions

Pin	Name	Description	Pin	Name	Description	
1	VREF	Reference voltage	8	GND	Ground	
2	GND	Ground	9	GND	Ground	
3	GND	Ground	10	GND	Ground	
4	VCC1	Supply voltage	11	VCC2	Supply voltage	
5	RFIN	RF input	12	RFOUT	RF output	
6	N/C	No connection	13	GND	Ground	
7	N/C	No connection	14	GND	Ground	

Electrical and Mechanical Specifications

The absolute maximum ratings of the AWB7132 are provided in Table 2. Recommended operating conditions are specified in Table 3, and electrical specifications are provided in Table 4.

Table 2. AWB7132 Absolute Maximum Ratings¹

Parameter	Minimum	Maximum	Units	
Supply voltage (VCC)	0	+5	V	
Reference voltage (VREF)	0	+3.5	V	
RF output power (POUT)		+28	dBm, modulated	
Storage temperature (TSTG)	-40	+150	°C	
Electrostatic discharge:				
Human Body Model, Class 1C ² Charged Device Model, Class 4 ³		2000 1000	V V	

¹ Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

ESD HANDLING: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device.

This device must be protected at all times from ESD when handling or transporting. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection.

Industry-standard ESD handling precautions should be used at all times.

Table 3. AWB7132 Recommended Operating Conditions¹

Parameter	Symbol	Min	Тур	Max	Units
Operating frequency	f	2300		2400	MHz
Supply voltage	Vcc	+3.2	+4.2	+4.5	V
Reference voltage:					
PA on PA off	VREF	+2.80 0	+2.85	+2.90 +0.5	V V
RF output power ²	Роит		+24.5		dBm
Case temperature ³	Tc	-40		+85	°C

The device may be operated safely over these conditions; however, parametric performance is guaranteed only over the conditions defined in the electrical specifications.

² JEDEC JS-001-2010.

³ JEDEC JESD22-C101D

² Typ RF output power is used during production test.

 $^{^3}$ Case temperature references the board temperature at the ground paddle on the backside of the package.

DATA SHEET • AWB7132: 2.30 TO 2.40 GHz SMALL-CELL POWER AMPLIFIER MODULE

Table 4. AWB7132 Electrical Specifications¹

(Tc = +25 °C, Vcc = +4.2 V, Vref = +2.85 V, 50 Ω system)

Parameter	Symbol	Test Condition	dition Min		Max	Units
Gain ²	G		27	29	34	dB
ACPR: 1,2,3		10 MHz LTE BW				
@ 10 MHz offset @ 20 MHz offset				–47 –58	-45 -50	dBc dBc
Power-added efficiency ^{1,2,3}			16	19		%
Thermal resistance	RJC	Junction to case		21.8		°C/W
Supply current ^{1,2,3}	VCC	Total through VCC pins	295	350	420	mA
Quiescent current	lcq		95	125	155	mA
Reference current		Through VREF pin	5	6.5	8	mA
Leakage current		VCC = +4.5 V, VREF = 0 V		1.5	5	μА
Harmonics:						
2fo 3fo, 4fo				-55 -58	-40 -45	dBc dBc
Input return loss			10	15		dB
P1dB		CW tone		33		dBm
RF switching time: ⁴		VCC = +4.2 V, VREF switched between 0 V and				
Rise time (PA off to on) Fall time (PA on to off)		+2.85 V			12 4	μs μs
Spurious output level (all spurious outputs)		$Pout \leq +24.5 \ dBm, in-band \ load \ VSWR < 5:1, \\ Out-of-band \ load \ VSWR < 10:1, applies \ over \ all \\ voltage \ and \ temperature \ operating \ ranges$			-60	dBc
Load mismatch stress with no permanent degradation or failure		VCC = +4.2 V, PIN = +0 dBm Applies over full operating temperature range	8:1			VSWR

Measured at 2350 MHz.

 $P_{\text{OUT}} = +24.5 \text{ dBm}.$

 $^{^{3}\,\,}$ E-TM1.1 LTE 10 MHz BW.

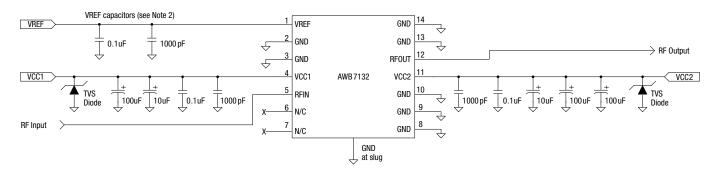
⁴ Rise Time defined from time at which VREF is switched from 0 V to +2.85 V, to time at which the RF output power achieves 90% of the average steady-state "on" level; Fall Time defined from time at which VREF is switched from +2.85 V to 0 V, to time at which the RF output power decreases to 10% of the average steady-state "on" level.

Evaluation Board Description

The AWB7132 Evaluation Board is used to test the performance of the AWB7132 device. A schematic of a typical application circuit is shown in Figure 3.

Shutdown Mode

The power amplifier can be placed in shutdown mode by applying logic low levels (see Operating Ranges table) to the V_{REF} voltage.



Notes:

- Applications that have large supply voltage transients may benefit from the use of TVS diodes. For such applications, recommended TVS diodes are SM05T1G or SMJ5.0A.
- To achieve the RF Switching Time specifications listed in Table 4, the maximum recommended capacitance on the VREF line is 0.01 μF.
 The noise on the VREF line should be kept as low as possible to minimize required capacitance.

204331-003

Figure 3. AWB7132 Evaluation Board Schematic

Package Dimensions

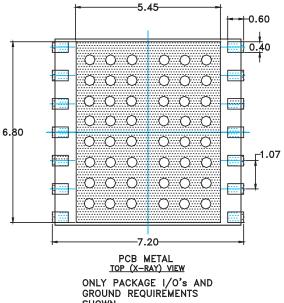
The PCB layout footprint drawing for the AWB7132 is shown in Figure 4. Typical part markings are shown in Figure 5. The package dimensions for the AWB7132 are shown in Figure 6. The tape and reel dimensions are provided in Figure 7.

Package and Handling Information

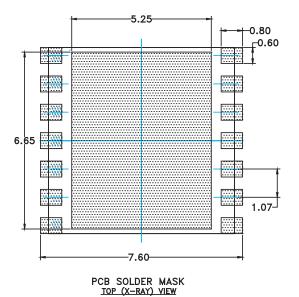
Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

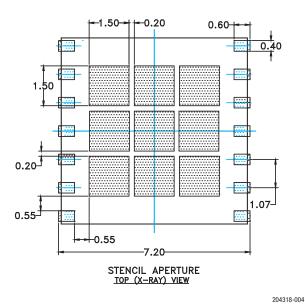
The AWB7132 can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.



SHOWN.





Notes:

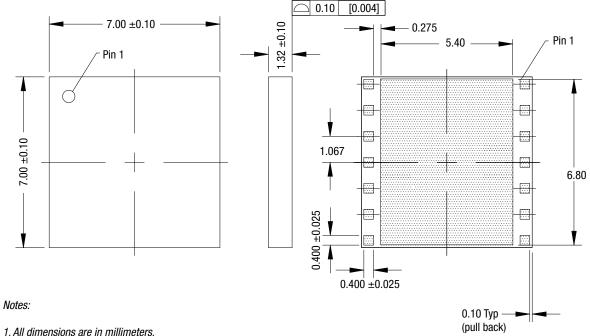
1. Unless specified, dimensions are symmetrical about center lines shown.

2. Dimensions are in millimeters.

 What shown in PCB Metal View are for reference only. Number and size of thermal vias required are dependent on heat dissipation requirements and the PCB process capability.

Figure 4. AWB7132 PCB Layout Footprint Dimensions

Figure 5. AWB7132 Typical Part Marking



- 1. All dimensions are in millimeters.
- 2. Unless specified otherwise, tolerance = ± 0.076 [0.003].
- 3. Pads (including center) are shown as uniform size for reference only. Actual pad size and location will vary within the minimum and maximum dimensions according to the specific laminate design.

204331-006

Figure 6. AWB7132 Package Dimensions

DATA SHEET • AWB7132: 2.30 TO 2.40 GHz SMALL-CELL POWER AMPLIFIER MODULE

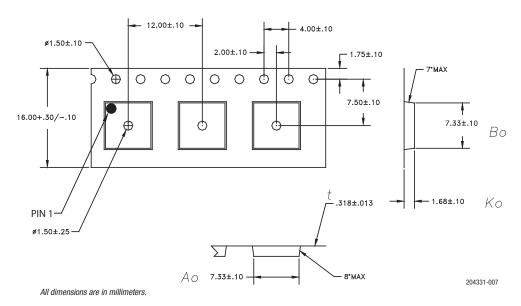


Figure 7. AWB7132 Tape and Reel Dimensions

Ordering Information

Model Number	Package Description	Component Packaging	
AWB7132P8	RoHS-compliant 14-pin 7 x 7 x 1.3 mm surface-mount module	2500-piece tape and reel	
EVB7132		Evaluation Board part number	

Copyright © 2017 Skyworks Solutions, Inc. All Rights Reserved.

Information in this document is provided in connection with Skyworks Solutions, Inc. ("Skyworks") products or services. These materials, including the information contained herein, are provided by Skyworks as a service to its customers and may be used for informational purposes only by the customer. Skyworks assumes no responsibility for errors or omissions in these materials or the information contained herein. Skyworks may change its documentation, products, services, specifications or product descriptions at any time, without notice. Skyworks makes no commitment to update the materials or information and shall have no responsibility whatsoever for conflicts, incompatibilities, or other difficulties arising from any future changes.

No license, whether express, implied, by estoppel or otherwise, is granted to any intellectual property rights by this document. Skyworks assumes no liability for any materials, products or information provided hereunder, including the sale, distribution, reproduction or use of Skyworks products, information or materials, except as may be provided in Skyworks Terms and Conditions of Sale

THE MATERIALS, PRODUCTS AND INFORMATION ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, WHETHER EXPRESS, IMPLIED, STATUTORY, OR OTHERWISE, INCLUDING FITNESS FOR A PARTICULAR PURPOSE OR USE, MERCHANTABILITY, PERFORMANCE, QUALITY OR NON-INFRINGEMENT OF ANY INTELLECTUAL PROPERTY RIGHT; ALL SUCH WARRANTIES ARE HEREBY EXPRESSLY DISCLAIMED. SKYWORKS DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. SKYWORKS SHALL NOT BE LIABLE FOR ANY DAMAGES, INCLUDING BUT NOT LIMITED TO ANY SPECIAL, INDIRECT, INCIDENTAL, STATUTORY, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS THAT MAY RESULT FROM THE USE OF THE MATERIALS OR INFORMATION, WHETHER OR NOT THE RECIPIENT OF MATERIALS HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGE.

Skyworks products are not intended for use in medical, lifesaving or life-sustaining applications, or other equipment in which the failure of the Skyworks products could lead to personal injury, death, physical or environmental damage. Skyworks customers using or selling Skyworks products for use in such applications do so at their own risk and agree to fully indemnify Skyworks for any damages resulting from such improper use or sale.

Customers are responsible for their products and applications using Skyworks products, which may deviate from published specifications as a result of design defects, errors, or operation of products outside of published parameters or design specifications. Customers should include design and operating safeguards to minimize these and other risks. Skyworks assumes no liability for applications assistance, customer product design, or damage to any equipment resulting from the use of Skyworks products outside of stated published specifications or parameters.

Skyworks and the Skyworks symbol are trademarks or registered trademarks of Skyworks Solutions, Inc., in the United States and other countries. Third-party brands and names are for identification purposes only, and are the property of their respective owners. Additional information, including relevant terms and conditions, posted at www.skyworksinc.com, are incorporated by reference